



ML501

1.9–2.7 GHz High IP3 Mixer with Integrated LO Amp

The Communications Edge™

Product Information

Product Features

- High dynamic range mixer with integrated LO driver
- +30 dBm Input IP3
- 8 dB Conversion Loss
- RF: 1900 – 2700 MHz
- LO: 1600 – 2500 MHz
- IF: 50 – 500 MHz
- 0 dBm Drive Level
- RoHS-compliant SOIC-8 pkg

Applications

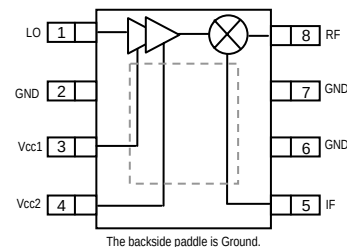
- 2.5/3G GSM/CDMA/WCDMA
- PCS/UMTS-band Mobile Infrastructure
- WiBro / WiLAN / WiMAX

Product Description

The ML501 high linearity upconverter or downconverter combines a passive GaAs MESFET mixer with an integrated HBT LO driver in a low-cost lead-free/green/RoHS-compliant SOIC-8 package. WJ's ML501 uses patented techniques to realize +30 dBm Input IP3 with 8 dB conversion loss using an LO drive level of 0 dBm in a downconverting application. The on-chip diplexer in the mixers allows for good matching on the RF and IF ports. The dual-stage LO driver provides a stable input power level into the mixer to allow for consistent performance over a wide range of LO power levels.

Typical applications include frequency up/down conversion, modulation and demodulation for receivers and transmitters used in 2.5G and 3G GSM/CDMA/WCDMA systems in the PCS, or UMTS frequency bands. They can also be used for WiBro/WiLAN/WiMAX infrastructure requiring high linearity frequency conversion.

Functional Diagram



Specifications ⁽¹⁾

Parameter	Units	Min	Typ	Max	Min	Typ	Max	Min	Typ	Max
RF Frequency Range	MHz		1900 – 2200		2200 – 2400			2400 – 2700		
LO Frequency Range	MHz		1600 – 2150		1900 – 2350			1900 – 2500		
IF Frequency Range	MHz		50 – 300		50 – 300			200 – 500		
SSB Conversion Loss	dB		8	9		8.1		8.4		
Input IP3 ⁽²⁾	dBm	+28	+30			+30		+28		
Input P1dB	dBm		+21			+20		+20		
LO – RF Isolation ⁽³⁾	dB		9			8		7		
LO – IF Isolation ⁽³⁾	dB		27			27		25		
RF – IF Isolation	dB		20			21		21		
Return Loss: RF Port	dB		16			17		17		
Return Loss: IF Port	dB		20			20		20		
Return Loss: LO Port	dB		15			12		11		
LO Drive Level	dBm	-2.5	0	2.5	-2.5	0	2.5	-2.5	0	2.5
Supply Voltage	V		+5			+5		+5		
Operating Current ⁽⁴⁾	mA	85	110	135		120		130		

1. Min / max limits are tested for the mixer in downconverting application with a low-side LO at 0 dBm at 25 °C with RF/IF = 1900/50, 2200/50, and 1900/300 MHz.

2. IP3 is measured with $\Delta f = 1$ MHz with $R_{Fin} = 0$ dBm / tone.

3. LO is injected with 0 dBm.

4. This refers to the operating current under LO drive. The current can be reduced by increasing the value of the R2 resistor slightly.

Absolute Maximum Rating

Parameter	Rating
Operating Case Temperature	-40 to +85 °C
Storage Temperature	-55 to +150 °C
DC Voltage	+5.5 V
LO Power	+10 dBm
Input IF / RF Power	+20 dBm

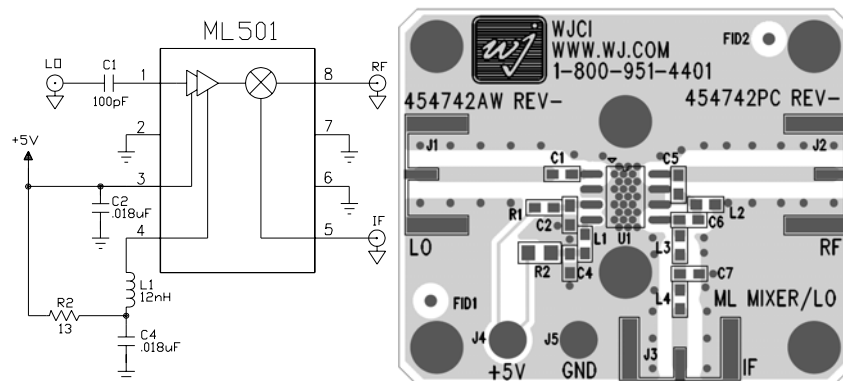
Operation of this device above any of these parameters may cause permanent damage.

Ordering Information

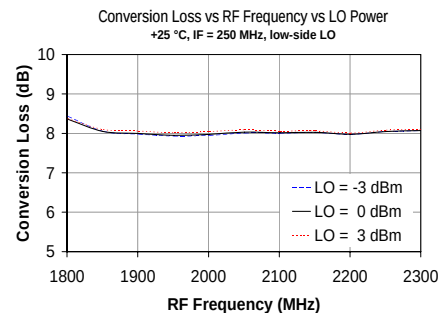
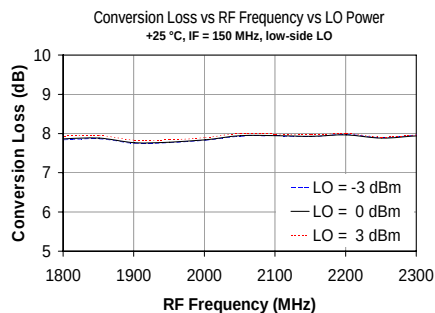
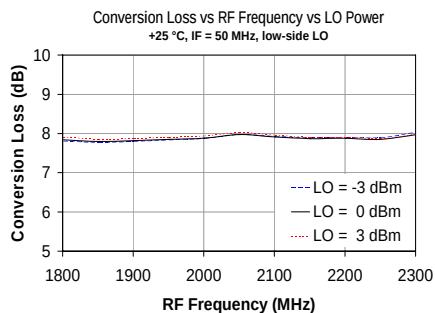
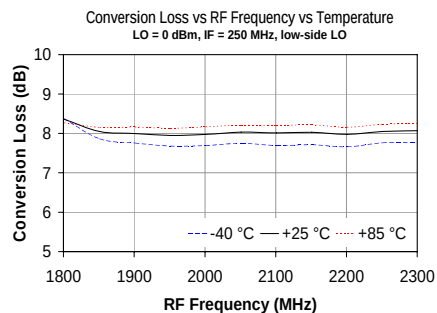
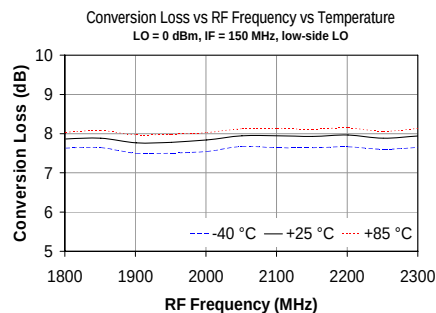
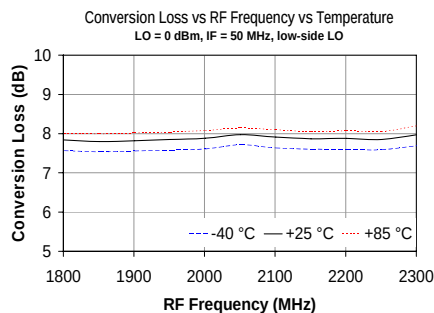
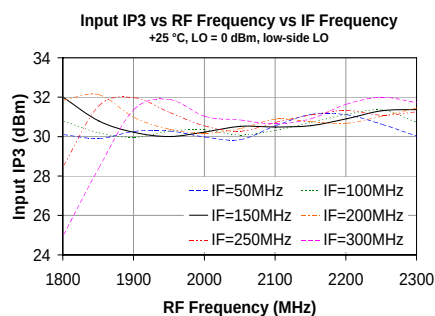
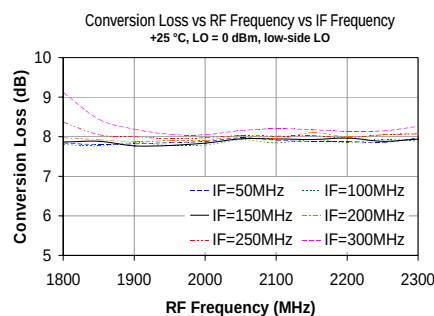
Part No.	Description
ML501-G	1.9–2.7 GHz High IP3 Mixer w/ Integrated LO Amp (lead-free/green/RoHS-compliant SOIC-8 package)
ML501-PCB	Full Assembled Evaluation Board

Specifications and information are subject to change without notice

Typical Downconversion Performance Plots

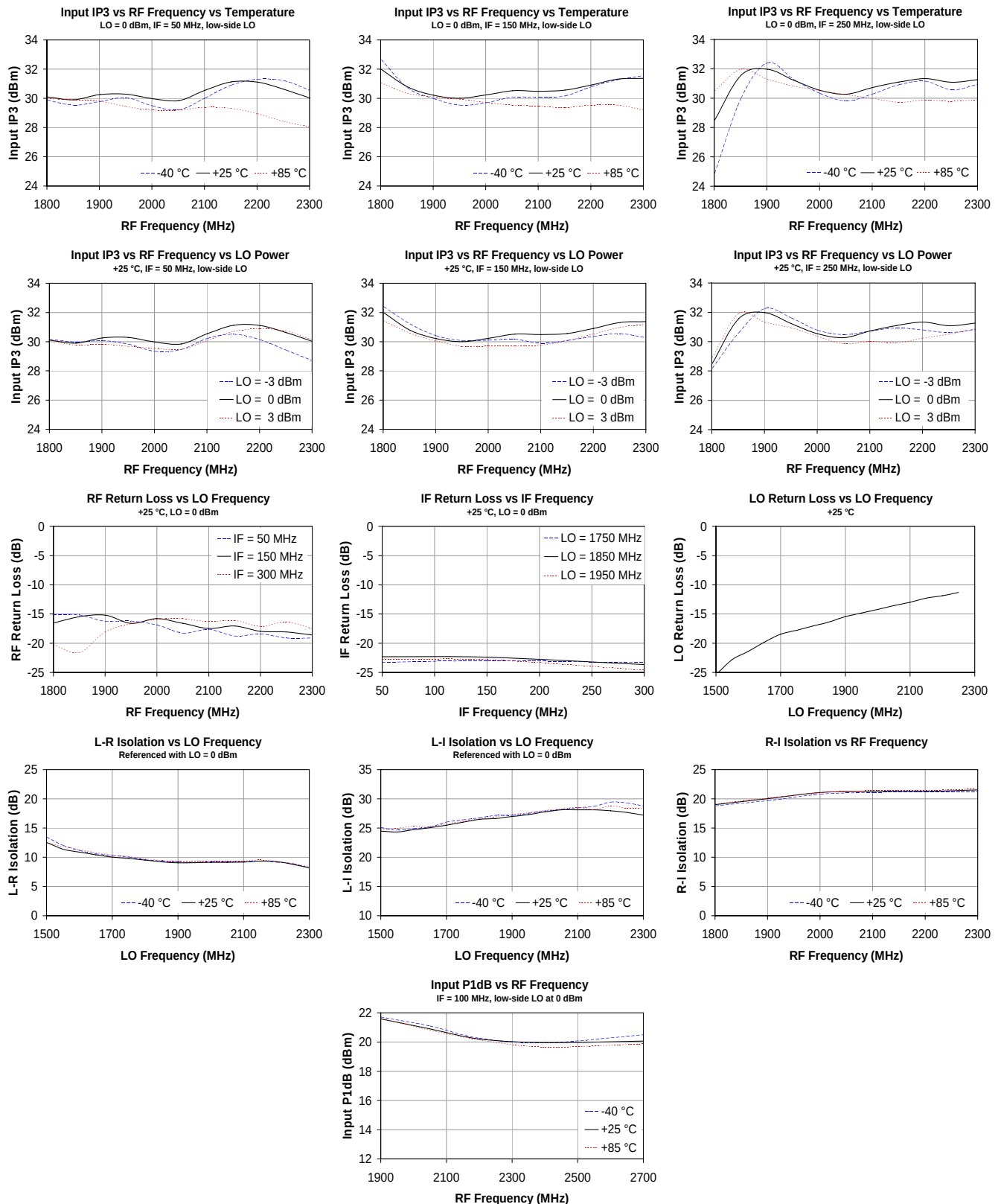


R1 is shown in the silkscreen but is not required for the ML501. A 0Ω jumper is placed in this spot on the PCB.





Typical Downconversion Performance Plots (cont'd) Performance using the circuitry on the ML501-PCB Evaluation Board





ML501

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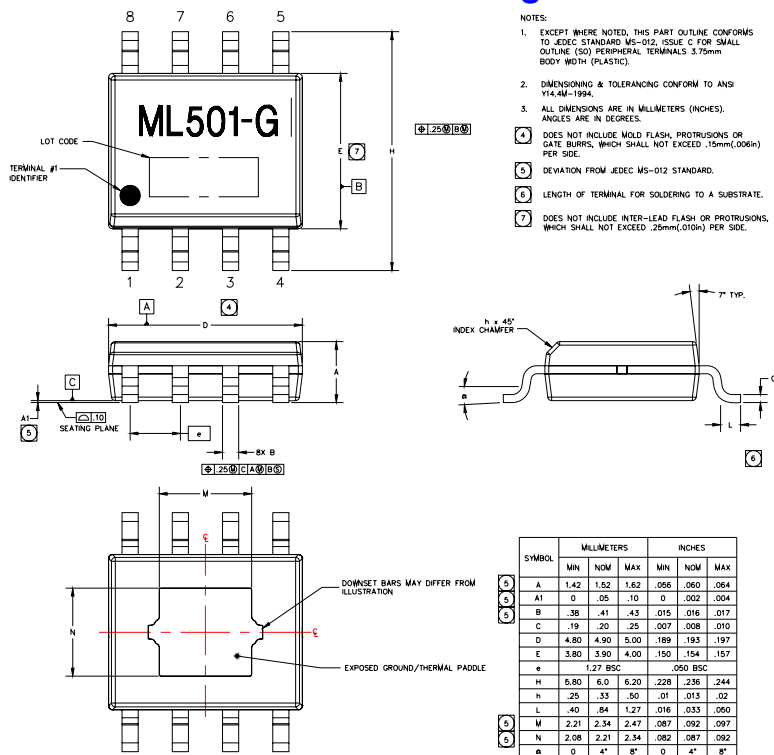
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Product Information

ML501-G Mechanical Information

This package is lead-free/green/RoHS-compliant. The plating material on the leads is NiPdAu. It is compatible with both lead-free (maximum 260 °C reflow temperature) and lead (maximum 245 °C reflow temperature) soldering processes.

Outline Drawing



Product Marking

The component will be lasermarked with a "ML501-G" product label with an alphanumeric lot code on the top surface of the package.

Tape and reel specifications for this part will be located on the website in the "Application Notes" section.

ESD / MSL Information



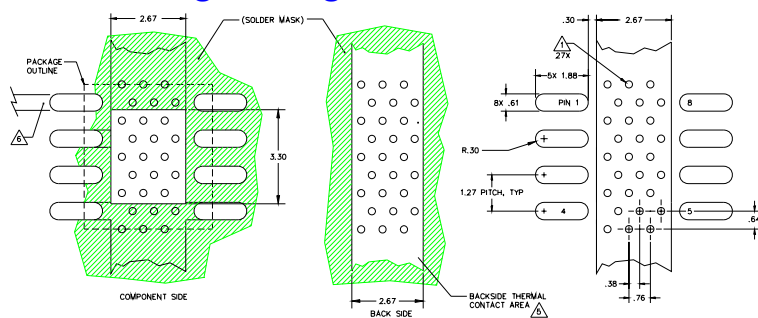
Caution! ESD sensitive device.

ESD Rating: Class 1B
 Value: Passes $\geq 500V$ to $<1000V$
 Test: Human Body Model (HBM)
 Standard: JEDEC Standard JESD22-A114

ESD Rating: Class IV
 Value: Passes $\geq 1000V$
 Test: Charged Device Model (CDM)
 Standard: JEDEC Standard JESD22-C101

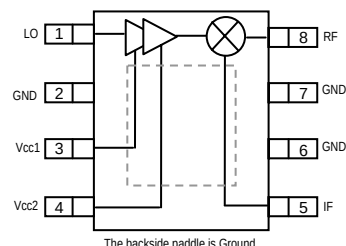
MSL Rating: Level 2 at +260 °C convection reflow
 Standard: JEDEC Standard J-STD-020

Mounting Configuration / Land Pattern



- Ground / thermal vias are critical for the proper performance of this device. Vias should use a .35mm (#8 / .0135") diameter drill and have a final plated thru diameter of .25 mm (.010").
- Add as much copper as possible to inner and outer layers near the part to ensure optimal thermal performance.
- Mounting screws can be added near the part to fasten the board to a heatsink. Ensure that the ground / thermal via region contacts the heatsink.
- All dimensions are in millimeters (inches). Angles are in degrees.
- Do not put solder mask on the backside of the PC board in the region where the board contacts the heatsink.
- RF trace width depends upon the PC board material and construction.
- Use 1 oz. Copper minimum.

Functional Pin Layout



Pin	Function
1	LO
2	GND
3	Vcc1
4	Vcc2
5	IF
6	GND
7	GND
8	RF

Backside paddle is RF and DC ground.

Thermal Specifications

Parameter	Rating
Operating Case Temperature	-40 to +85 °C
Thermal Resistance, Rth	104 °C / W

Specifications and information are subject to change without notice



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